

SMP80MC

TRISIL[™] for telecom equipment protection

Features

- Bidirectional crowbar protection
- Voltage: range from 120 V to 320 V
- Low V_{BO} / V_R ratio
- Micro capacitance equal to 12 pF @ 50 V
- Low leakage current : I_R = 2 µA max
- Holding current: I_H = 150 mA min
- Repetitive peak pulse current :
- I_{PP} = 80 A (10/1000 µs)

Main applications

Any sensitive equipment requiring protection against lightning strikes and power crossing:

Terminals (phone, fax, modem...) and central office equipment

Description

The SMP80MC is a series of micro capacitance transient surge arrestors designed for the protection of high debit rate communication equipment on CPE side. Its micro capacitance avoids any distortion of the signal and is compatible with digital transmission like ADSL2 and ADSL2+.

Benefits

Trisils are not subject to ageing and provide a fail safe mode in short circuit for a better protection. They are used to help equipment to meet main standards such as UL1950, IEC950 / CSA C22.2 and UL1459. They have UL94 V0 approved resin. SMB package is JEDEC registered (DO-214AA). Trisils comply with the following standards GR-1089 Core, ITU-T-K20/K21, VDE0433, VDE0878, IEC61000-4-5 and FCC part 68.

TM: TRISIL is a trademark of STMicroelectronics.



Order codes

Part Number	Marking
SMP80MC-120	TP12
SMP80MC-140	TP14
SMP80MC-160	TP16
SMP80MC-200	TP20
SMP80MC-230	TP23
SMP80MC-270	TP27
SMP80MC-320	TP32

Schematic diagram



1 Characteristics

Table 1. Complies with the following standards						
STANDARD	RD Peak Surge Voltage (V) Waveform Voltage Required peak current (A) Current waveform		Minimum serial resistor to meet standard (Ω)			
GR-1089 Core First level	2500 1000	2/10 μs 10/1000 μs	500 100	2/10 μs 10/1000 μs	5 2.5	
GR-1089 Core Second level	5000	2/10 µs	500	2/10 µs	10	
GR-1089 Core Intra-building	1500	2/10 µs	100	2/10 µs	0	
ITU-T-K20/K21	6000 1500	10/700 µs	150 37.5	5/310 µs	10 0	
ITU-T-K20 (IEC61000-4-2)	8000 15000	1/60 ns	ESD contact ESD air di	•	0 0	
VDE0433	4000 2000	10/700 µs	100 50	5/310 µs	0 0	
VDE0878	4000 2000	1.2/50 µs	100 50	1/20 µs	0 0	
IEC61000-4-5	4000 4000	10/700 μs 1.2/50 μs	100 100	5/310 μs 8/20 μs	0 0	
FCC Part 68, lightning surge type A	1500 800	10/160 μs 10/560 μs	200 100	10/160 μs 10/560 μs	2.5 0	
FCC Part 68, lightning surge type B	1000	9/720 µs	25	5/320 µs	0	

Table 1. Complies with the following standards
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Table 2.	Absolute ratings	(T _{amb} = 25° C)
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Symbol	Parameter	Conditions	Value	Unit	
		10/1000 μs 8/20 μs	80 200		
		10/560 µs	100		
Ipp	Repetitive peak pulse current (see Figure 1)	5/310 µs	120	Α	
		10/160 µs	150		
		1/20 µs	200		
		2/10 µs	250		
I _{FS}	Fail-safe mode : maximum current ⁽¹⁾	8/20 μs	5	kA	
		t = 0.2 s	14	А	
 	Non repetitive surge peak on-state current	t = 1 s	8		
ITSM	(sinusoidal)	t = 2 s	6.5	~	
		t = 15 mn	2		
l ² t	I ² t value for fusing	t = 16.6 ms	7.5	A ² s	
		t = 20 ms	7.8	Λ3	
T _{stg}	Storage temperature range	-55 to 150	°C		
Ťj	Maximum junction temperature		150		
ΤĹ	Maximum lead temperature for soldering durir	260	°C		

1. in fail safe mode, the device acts as a short circuit

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient (with recommended footprint)	100	° C/W
R _{th(j-l)}	Junction to leads	20	° C/W

Table 3.Thermal resistances

Table 4.Electrical characteristics ($T_{amb} = 25^{\circ} C$)

	(
Symbol	Parameter		
V_{RM}	Stand-off voltage		
V_{BR}	Breakdown voltage		
V_{BO}	Breakover voltage		
I _{RM}	Leakage current		
I _{PP}	Peak pulse current		
I _{BO}	Breakover current		
Ι _Η	Holding current		
V _R	Continuous reverse voltage		
I _R	Leakage current at V _R		
С	Capacitance		



	I _{RM} @	V _{RM}	I _R @	V _R ⁽¹⁾	Dynamic V _{BO} ⁽²⁾		atic ⁹ I _{BO} ⁽³⁾	I _H ⁽⁴⁾	C ⁽⁵⁾	C ⁽⁶⁾
Types	max.		max.		max.	max.	max.	min.	typ.	typ.
	μA	v	μA	v	v	v	mA	mA	pF	pF
SMP80MC-120		108		120	155	155				
SMP80MC-140		126		140	180	180				
SMP80MC-160		144		160	205	205				
SMP80MC-200	2	180	5	200	255	255	800	150	12	25
SMP80MC-230		207		230	295	295				
SMP80MC-270		243		270	345	345				
SMP80MC-320		290		320	400	400				

1. I_R measured at V_R guarantee V_{BR} min \ge VR

2. See *Figure 9* functional test circuit 1

3. See Figure 10 test circuit 2

4. See *Figure 11* functional holding current test circuit 3

5. $V_R = 50$ V bias, $V_{RMS} = 1$ V, F= 1 MHz

6. $V_R = 2 V \text{ bias}, V_{RMS} = 1 V, F = 1 \text{ MHz}$



F=50

1.E+03

Ш

1.E+02

Figure 1. Pulse waveform





Figure 3. On-state voltage versus on-state current (typical values)

Figure 4. Relative variation of holding current versus junction temperature

1.E+00

t(s)

1.E+01



Figure 5. Relative variation of breakover voltage versus junction temperature

Figure 6. Relative variation of leakage current versus junction temperature (typical values)





Figure 7. Variation of thermal impedance junction to ambient versus pulse duration (Printed circuit board FR4, SCu=35µm, recommended pad layout)











Figure 10. Test circuit 2 for IBO and VBO parameters





2 Ordering Information Scheme

	SMP	80	MC	- xxx
Trisil surface mount				
Repetitive peak pulse current				
80 = 80A				
Capacitance				
MC = Micro Capacitance				
Voltage				
120 = 120 V				
140 = 140 V 160 = 160 V				
200 = 200 V				
230 = 230 V				
270 = 270 V				
320 = 320 V				



3 Package information

• Epoxy meets UL94, V0

Table 5. SMB dimensions



Figure 12. Footprint (dimensions in mm)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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4 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
SMP80MC-120	TP12				
SMP80MC-140	TP14				
SMP80MC-160	TP16				
SMP80MC-200	TP20	SMB	0.11 g	2500	Tape and reel
SMP80MC-230	TP23				
SMP80MC-270	TP27				
SMP80MC-320	TP32				

5 Revision history

Date	Revision	Description of Changes
September-2001	1	First issue.
11-May-2005	2	New types introduction.
20-Jun-2005	3	Qualification of new types
18-Jan-2007	4	Reformatted to current standards. Added product SMP80MC-320



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